

Ultra-Low Noise and Distortion, High Speed Op-Amp

Preliminary Technical Data

AD8099

FEATURES

Ultra-Low Noise 0.95nV/rt Hz 2.6pA/rt Hz **Ultra-Low Distortion** 2nd Harmonic -100dB @ 1MHz -92dB @ 10MHz 3rd Harmonic -100dB @ 1MHz -92dB @ 10MHz High Speed 500MHz, (G = +2)500MHz (G=+10) 1600 V/s (G=+10) **External Compensation** Low Power 15mA Is Offset Voltage 1mV Max Wide Supply Voltage Range

5V to 12V APPLICATIONS

Pre-amp
Receiver
Instrumentation
IF and Baseband Amplifier
Filters
A-to-D Driver
DAC Buffer

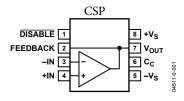
GENERAL DESCRIPTION

The AD8099 is a ultra low noise (0.95nV/vHz) and distortion (92dBc@10MHz) voltage feedback op-amp. Few op amps have noise or distortion as good as the AD8099, none have the combination making it ideal for 16 and 18 bit systems. Incredibly, this highest performance high-speed op amp uses only 15mA of supply current and contains a disable pin that lowers the power and puts the amplifier output into high impedance. ADI's proprietary 2nd generation XFCB process enables such high performance amplifiers with relatively low power.

Featuring external compensation the AD8099 allows the user to chose the gain bandwidth product that best suites the application. The AD8099 is externally compensated enabling gains from +2 to +10 with minimal trade-off in bandwidth. The AD8099 also features extremely high slew rate of 1600V/us giving the designer the flexibility to use the entire dynamic range without trading off bandwidth and distortion. The AD8099 is a very well behaved amp that settles to 0.002% in

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CONNECTION DIAGRAMS



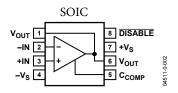


Figure 1.0 SOIC and CSP Pinouts

work in a wide variety of applications.

35ns and has fast overload recovery of 50ns. The AD8099 amplifier offers low power of 15 mA, and is capable of driving 100ohm loads at break through performance levels. With the wide supply voltage range (5V to 12V), low offset voltage (1mV max), wide bandwidth (500MHz for low gains) and a GBWP up to 3GHz; the AD8099 is designed to

The AD8099 amplifier is available in tiny lead frame chip-scale packaging (LFCSP) with new standard pin out that is specifically optimized for high performance high-speed amplifiers. The new package and pin out enables the breakthrough performance that previously was not achievable with amplifiers.

The AD8099 is also offered in the industry standard package (8-lead SOIC) with the industry standard pin out. The AD8099 is rated to work over the extended industrial temperature range, -40C to +125C

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Preliminary Technical Data

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REVISION HISTORY

SPECIFICATIONS

SPECIFICATIONS WITH ±5 V SUPPLY

Table 1. $V_S = \pm 5$ V @ $T_A = 25$ °C, G = +2, $C_C = 6.8$ pF, $C_L = 5$ pF, $R_L = 100\Omega$ to ground, unless otherwise noted

Parameter	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
–3 dB Bandwidth	$G = +2, V_o = 0.2Vp-p$		500		MHz
	$G = +2, V_o = 2Vp-p$		70		MHz
	$G = +10, V_o = 0.2Vp-p$		500		MHz
	$G = +10, V_o = 2Vp-p$		70		MHz
Bandwidth for 0.1 dB Flatness	$G = +2, V_0 = 0.2 \text{ V p-p}$		150		MHz
Slew Rate	$G = +2$, $V_0 = 2$ V Step		500		V/µs
Settling Time to 0.1%	$G = +2$, $V_0 = 2$ V Step		12		ns
Overload recovery Input/Output			50/20		ns
NOISE/DISTORTION PERFORMANCE					
2 nd /3 rd harmonic)	$f_C = 1 \text{ MHz}, V_O = 2 \text{ V p-p}$		-100/100		dBc
2 nd /3 rd harmonic	$f_c = 10 \text{ MHz}, V_0 = 2 \text{ V p-p}$		-85/87		dBc
2 nd /3 rd harmonic)	$f_{c} = 1 \text{ MHz}, V_{o} = 2 \text{ V p-p} R_{L} = 500 \Omega$		-100/100		dBc
2 nd /3 rd harmonic	$f_{c} = 10 \text{ MHz}, V_{o} = 2 \text{ V p-p R}_{L} = 500 \Omega$		-92/92		dBc
Input Voltage Noise	f = 100 kHz		1		nV/√ Hz
Input Current Noise	f = 100 kHz		2.6		pA/√Hz
Differential Gain Error	NTSC, $G = +2$, $R_1 = 150 \Omega$		0.01		%
Differential Phase Error	NTSC, $G = +2$, $R_L = 150 \Omega$		0.01		Degree
DC PERFORMANCE					
Input Offset Voltage			0.2	1	mV
	T _{min} - T _{max}			1.5	mV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		3		μV/°C
Input Bias Current ¹			3		μΑ
	T _{MIN} to T _{MAX}		8		μΑ
Input Offset Current					μΑ
Open-Loop Gain	$V_0 = +/-2.5$		86		dB
INPUT CHARACTERISTICS					
Common-Mode Input Impedance			1/1.8		MΩ/pF
Differential Input Impedance			4/2.0		MΩ/pF
Input Common-Mode Voltage Range			-3.6 to 3.6		V
Common-Mode Rejection Ratio	$V_{CM} = +/-2.5$		90		dB
OUTPUT CHARACTERISTICS					.,
Output Voltage Swing	$R_L = 500\Omega$		-3.5 to 3.5		٧.
Short-Circuit Current	$V_0 = +/-3.0 \text{ V}$		100		mA
Capacitive Load Drive	30% Overshoot		35		pF
POWER SUPPLY		_			.,
Operating Range		5	15	12	٧
Quiescent Current/Amplifier		12	15	18	mA
Power Supply Rejection Ratio	$V_s \pm 1 V$		-80		dB

 $^{^{\}rm 1} \mbox{Plus}$ (or no sign) indicates current into pin; minus indicates current out of pin.

AD8099

SPECIFICATIONS WITH +5 V SUPPLY

Table 2. $V_S = +5 \ V \ @\ T_A = 25^{\circ}C$, G = +2, $C_C = 6.8 pF$, $C_L = 5 pF$, $R_L = 100 \Omega$ to ground, unless otherwise noted

Parameter	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
–3 dB Bandwidth	$G = +2, V_o = 0.2Vp-p$		500		MHz
	$G = +2, V_o = 2Vp-p$		70		MHz
	$G = +10, V_o = 0.2Vp-p$		500		MHz
	$G = +10, V_o = 2Vp-p$		70		MHz
Bandwidth for 0.1 dB Flatness	$G = +2, V_0 = 0.2 \text{ V p-p}$		150		MHz
Slew Rate	$G = +2$, $V_0 = 2$ V Step		500		V/µs
Settling Time to 0.1%	$G = +2, V_0 = 2 \text{ V Step}$		12		ns
Overload recovery Input/Output			50/20		ns
NOISE/DISTORTION PERFORMANCE					
2 nd /3 rd harmonic)	$f_C = 1 \text{ MHz}, V_O = 2 \text{ V p-p}$		-100/100		dBc
2 nd /3 rd harmonic	$f_c = 10 \text{ MHz}, V_0 = 2 \text{ V p-p}$		-85/87		dBc
2 nd /3 rd harmonic)	$f_c = 1 \text{ MHz}, V_0 = 2 \text{ V p-p} R_L = 500 \Omega$		-100/100		dBc
2 nd /3 rd harmonic	$f_c = 10 \text{ MHz}, V_0 = 2 \text{ V p-p } R_L = 500 \Omega$		-92/92		dBc
Input Voltage Noise	f = 100 kHz		1		nV/√ Hz
Input Current Noise	f = 100 kHz		2.6		pA/√Hz
Differential Gain Error	NTSC, $G = +2$, $R_1 = 150 Ω$		0.01		%
Differential Phase Error	NTSC, $G = +2$, $R_L = 150 \Omega$		0.01		Degree
DC PERFORMANCE	1413C, G = +2, N[= 130 S2				J cg.cc
Input Offset Voltage			0.2	1	mV
input onset voltage	T _{min} - T _{max}		0.2	1.5	mV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		3	1.5	μV/°C
Input Bias Current ¹			3		μΑ
·	T _{MIN} to T _{MAX}		8		μA
Input Offset Current					μΑ
Open-Loop Gain	$V_0 = +/-2.5$		86		dB
INPUT CHARACTERISTICS					
Common-Mode Input Impedance			1/1.8		MΩ/pF
Differential Input Impedance			4/2.0		MΩ/pF
Input Common-Mode Voltage Range			-3.6 to 3.6		V
Common-Mode Rejection Ratio	$V_{CM} = +/-2.5$		90		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	$R_L = 500\Omega$		-3.5 to 3.5		V
Short-Circuit Current	$V_0 = +/-3.0 \text{ V}$		100		mA
Capacitive Load Drive	30% Overshoot		35		pF
POWER SUPPLY					
Operating Range		5	15	12	V
Quiescent Current/Amplifier	V - 1V	12	15	18	mA
Power Supply Rejection Ratio	$V_s \pm 1 V$		-80		dB

¹ Plus (or no sign) indicates current into pin; minus indicates current out of pin.

TYPICAL PERFORMANCE CHARACTERISTICS

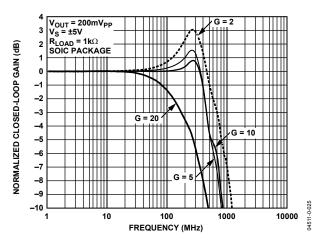


Figure 2. Small Signal Gains vs. Frequency (SOIC)

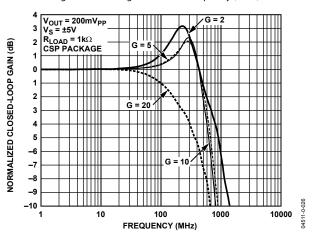


Figure 3. Small Signal Gains vs. Frequency (CSP)

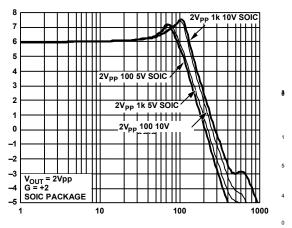


Figure 4. Large Signal Gain vs. Various Loads and Supplies SOIC

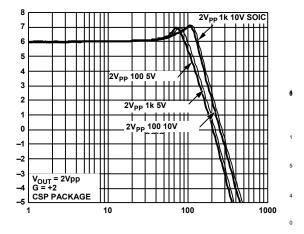


Figure 5. Large Signal Gain vs. Various Loads and Supplies CSP

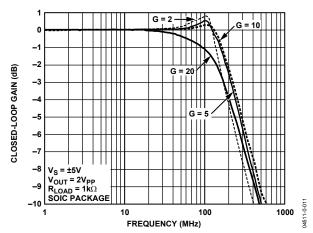


Figure 6. Various Large Signal Gains vs. Frequency SOIC

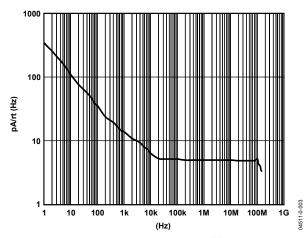


Figure 7 . Input Current Noise vs. Frequency Disable Pin=+Vs

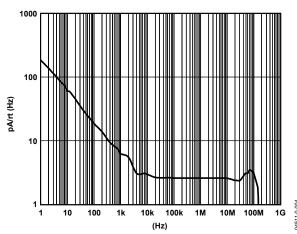


Figure 8. Input Current Noise vs. Frequency, Disable Pin = Open

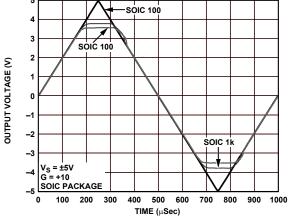


Figure 9. Output Overdrive (SOIC)

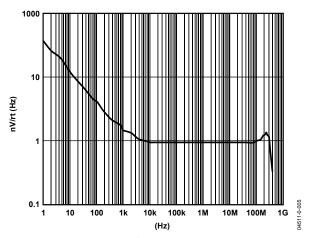


Figure 10. Voltage Noise vs. Frequency

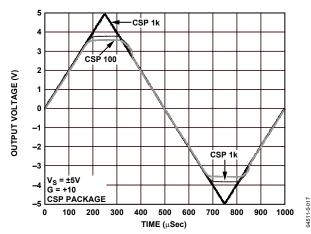


Figure 11. Output Overdrive (CSP)

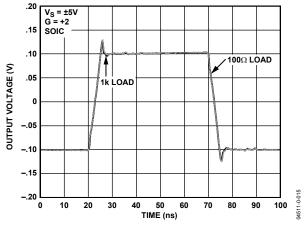


Figure 12 Small Signal Pulse Response vs. Rload

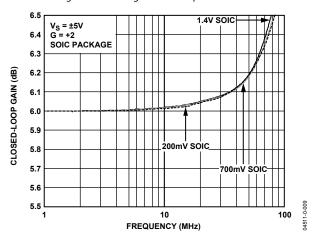


Figure 23..0.1dB Flatness (SOIC)

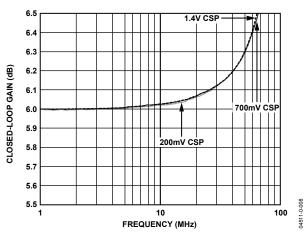


Figure 14. 0.1dB Flatness (CSP)

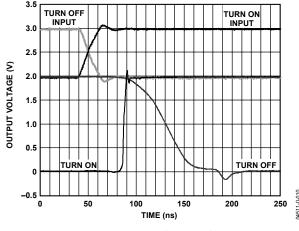


Figure 15. Switching Speed

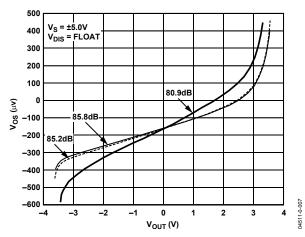


Figure 16. Input Offset Voltage vs. Output Voltage vs. Open Loop Gain

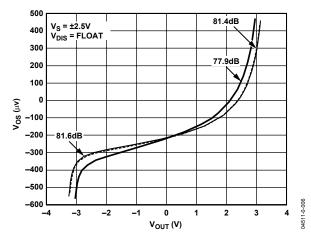


Figure 17 Input Offset Voltage vs. Output Voltage vs. Open Loop Gain

DESIGN TOOLS AND TECHNICAL SUPPORT

Analog Devices is committed to its customers by providing technical support and online design tools. ADI offers technical

support through free evaluation boards, sample ICs, spice models, interactive evaluation tools, application notes, and phone and email support—all available at www.analog.com

OUTLINE DIMENSIONS

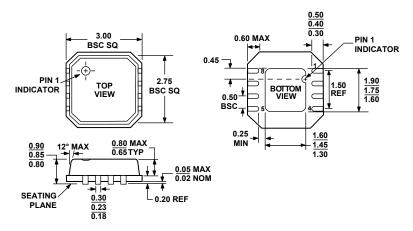
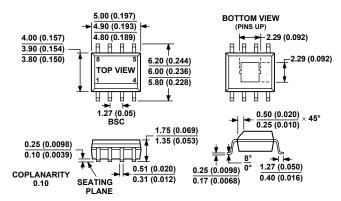


Figure 3.



COMPLIANT TO JEDEC STANDARDS MS-012
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-0FF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 4.

ORDERING GUIDE

	Minimum Ordering	Temperature	Package	Package
Model	Quantity	Range	Description	Option
AD8099AR*	1	-40°C to +125°C	8-Lead SOIC	R-8
AD8099AR-REEL*	2,500	-40°C to +125°C	8-Lead SOIC	R-8
AD8099AR-REEL7*	1,000	-40°C to +125°C	8-Lead SOIC	R-8
AD8099CP-R2	250	-40°C to +125°C	8-Lead CSP	CP-8
AD8099CP-REEL	5,000	-40°C to +125°C	8-Lead CSP	CP-8
AD8099CP-REEL7	1,500	-40°C to +125°C	8-Lead CSP	CP-8

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

